

NCE Automotive N-Channel Super Trench Power MOSFET

Description

The NCEAP6035AG uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{\text{DS(ON)}}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

Application

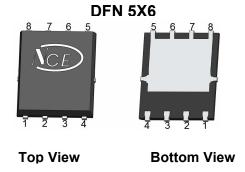
- Automotive application
- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

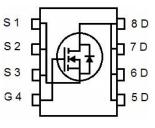
General Features

• V_{DS} =60V,I_D =48A

 $R_{DS(ON)}$ =9.8m Ω (typical) @ V_{GS}=10V $R_{DS(ON)}$ =12.5m Ω (typical) @ V_{GS}=4.5V

- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 175°C operating temperature
- Pb-free lead plating;RoHScompliant
- Halogen-freeaccordingtoIEC61249-2-21
- 100% UIS tested
- 100% ΔVds tested
- AEC-Q101 qualified





Schematic Diagram

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AP6035AG	NCEAP6035AG	DFN5X6-8L	-	-	-

Absolute Maximum Ratings (T_c=25℃unless otherwise noted)

<u> </u>				
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	60	V	
Gate-Source Voltage	V _G s	±20	V	
Drain Current-Continuous	I _D	48	А	
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	34	А	
Pulsed Drain Current	I _{DM}	192	А	
Maximum Power Dissipation	P _D	52	W	
Derating factor		0.35	W/°C	
Single pulse avalanche energy (Note 1)	Eas	96	mJ	
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 175	$^{\circ}$ C	



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NCEAP6035AG

Thermal Characteristic

Thermal Resistance, Junction-to-Case	R _{eJC}	2.9	°C/W
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Electrical Characteristics (T_C=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	60	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =60V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	$V_{GS}=\pm20V, V_{DS}=0V$	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS},I_{D}=250\mu A$	1.2	1.7	2.4	V
Davis Course On Otata Basistana		V _{GS} =10V, I _D =20A	-	9.8	11	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =20A	-	12.5	14.5	
Forward Transconductance	g FS	V _{DS} =5V,I _D =20A		60	-	S
Dynamic Characteristics						
Input Capacitance	C _{lss}	V _{DS} =30V,V _{GS} =0V,	-	1040	-	pF
Output Capacitance	Coss		-	156	-	pF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz		14	-	pF
Switching Characteristics (Note 2)						
Turn-on Delay Time	t _{d(on)}		-	4.3	-	nS
Turn-on Rise Time	t _r	V_{DD} =30V, I_D =20A V_{GS} =10V, R_G =1.6 Ω	-	2.7	-	nS
Turn-Off Delay Time	t _{d(off)}		-	13.8	-	nS
Turn-Off Fall Time	t _f		-	2.7	-	nS
Total Gate Charge	Qg	V _{DS} =30V,I _D =20A,	-	22.6	-	nC
Gate-Source Charge	Qgs		-	4.7	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V		3.7	-	nC
Drain-Source Diode Characteristics	-		'		'	
Diode Forward Voltage	V _{SD}	V _{GS} =0V,I _S =20A	-	-	1.2	V
Diode Forward Current	Is		-	-	48	Α
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F =20A	-	18	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/μs	-	12	-	nC

Notes:

- 1. EAS condition : Tj=25 $^{\circ}\text{C}$,VDD=-20V,VG=-10V,L=0.5mH,Rg=25 Ω
- 2. Guaranteed by design, not subject to production
- 3. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of T_{J(MAX)}=175°C. The SOA curve provides a single pulse rating.



Typical Electrical and Thermal Characteristics

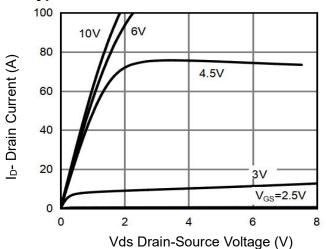


Figure 1 Output Characteristics

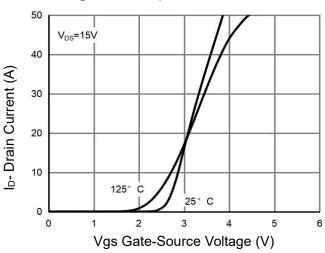


Figure 2 Transfer Characteristics

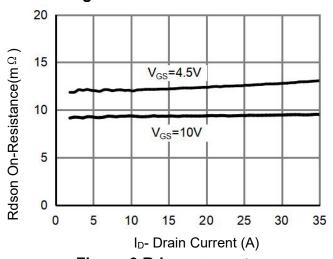


Figure 3 Rdson- Drain Current

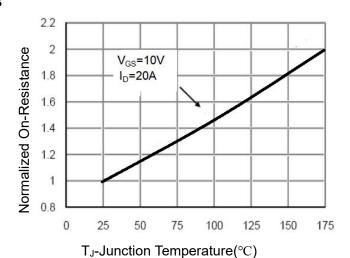


Figure 4 Rdson-Junction Temperature

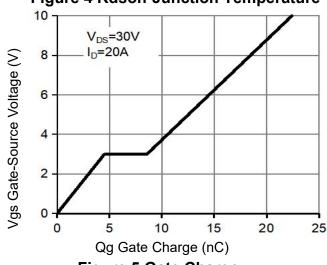


Figure 5 Gate Charge

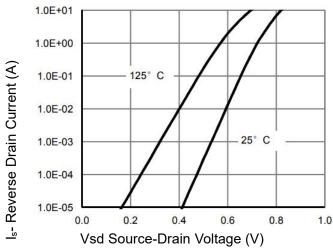


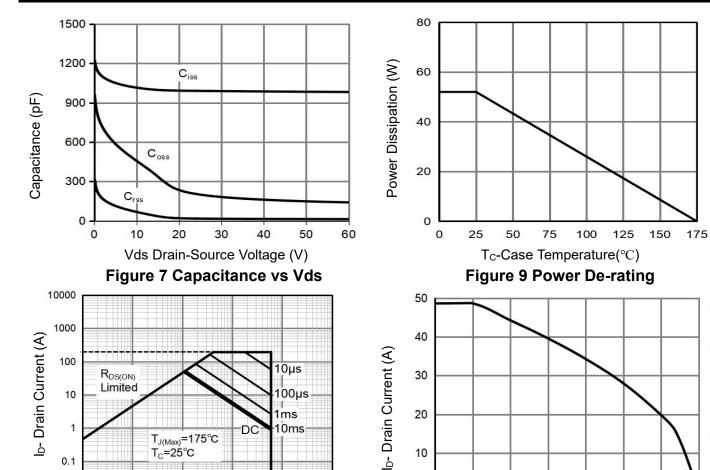
Figure 6 Source- Drain Diode Forward



0.01

0.01

0.1



1000

Vds Drain-Source Voltage (V)
Figure 8 Safe Operation Area (Note3)

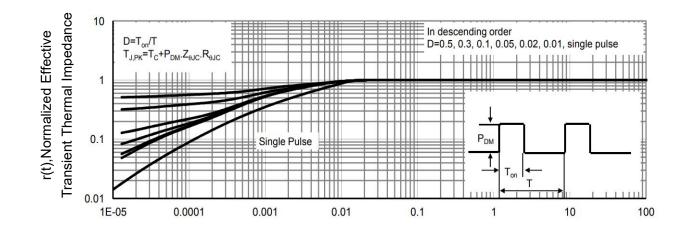


100

125

150

175



0

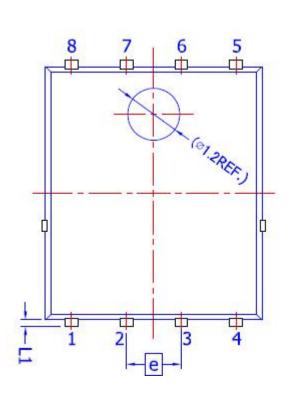
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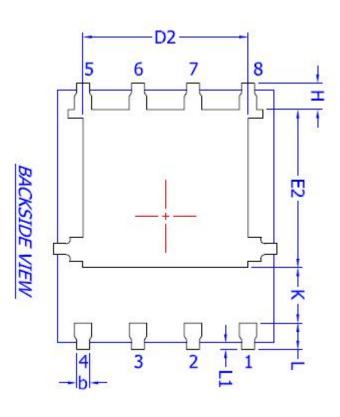
Figure 11 Normalized Maximum Transient Thermal Impedance

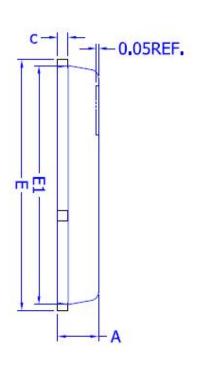
Square Wave Pluse Duration(sec)

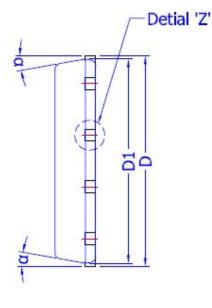


PDFN5X6-8L Package Information









5111	MIL	LIMETE	RS
DIM.	MIN.	NOM.	MAX.
Α	0.90	1.00	1.10
A1	0	-	0.05
Ь	0.30	0.40	0.50
С	0.20	0.25	0.30
D		5.15 BSC	?
D1	5.00 BSC		
D2	3.76	3.81	3.86
Ε	6.15 BSC		
E1	5.80	5.85	5.90
E2	3.45	3.65	3.85
e	1.27 BSC		
Н	0.51	0.61	0.71
K	1.10	(##)	-
L	0.51	0.61	0.71
L1	0.08	0.15	0.23
α	10°	110	12°



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NCEAP6035AG

Revision History

Revision	Date	Subjects
V1.0	2023.06.15	Product data sheet

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